



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V(BR)DSS	R _{DS(on)} Max	I _D max T _A = 25°C (Notes 4)
	$200m\Omega @ V_{GS} = 4.5V$	1.73A
20V	260mΩ @ V_{GS} = 2.5V	1.50A
	400mΩ @ V _{GS} = 1.8V	1.27A
	$500m\Omega @ V_{GS} = 1.5V$	1.15A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

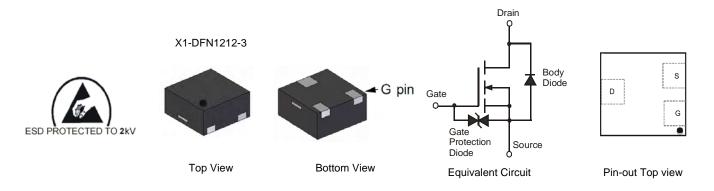
Load switch

Features and Benefits

- Low Gate Threshold Voltage •
- Fast Switching Speed •
- "Lead Free", RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- **ESD Protected Gate 2KV**
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1212-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.005 grams (approximate)



Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN2300UFD-7	KS2	7	8	3000

Notes: 1. No purposefully added lead

2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information

	KS2	
	ΥM	
•		

KS2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Eale Coac no)												
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		А	I	3	С		D		E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D





Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±8	V
	a	$T_{A} = 25^{\circ}C$ (Note 4)		1.73	
	Steady State	T _A = 85°C (Note 4)	I _D	1.34	А
	Siale	$T_A = 25^{\circ}C$ (Note 5)		1.21	
Pulsed Drain Current (Note 6)			I _{DM}	6.0	А

Thermal Characteristics @TA = 25°C unless otherwise specified

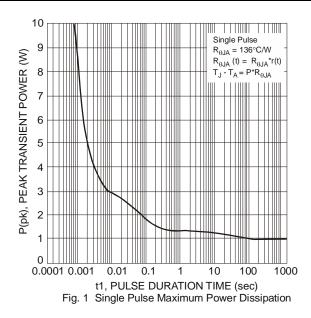
Characteristic	Symbol	Value	Unit	
Power Dissipation	(Note 4)	D	0.96	W
	(Note 5)	PD	0.47	W
Thermal Resistance, Junction to Ambient	(Note 4)	В	130	°C/W
Thermal Resistance, Junction to Ambient	(Note 5)	R _{θJA}	265	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

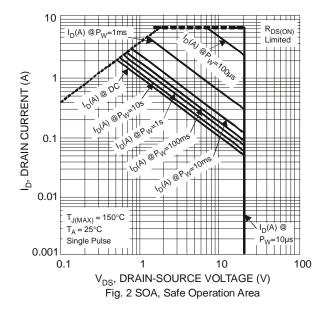
Notes: 4. For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

5. Same as note 4, except the device is mounted on minimum recommended pad layout.

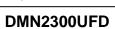
6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

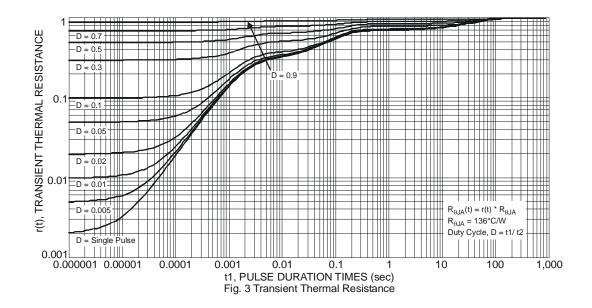
Thermal Characteristics











Electrical Characteristics @T_A = 25°C unless otherwise specified

	-	-	-		-		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current T _J = 25°C	I _{DSS}	-	-	1	μΑ	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±10	μΑ	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)	<u>.</u>						
Gate Threshold Voltage	V _{GS(th)}	0.45	-	0.95	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
				200		$V_{GS} = 4.5V, I_D = 900mA$	
Static Drain-Source On-Resistance	Б	-		260		$V_{GS} = 2.5V, I_D = 800mA$	
Static Drain-Source Off-Resistance	R _{DS (ON)}		-	400	mΩ	$V_{GS} = 1.8V, I_D = 700mA$	
				500		$V_{GS} = 1.5V, I_D = 200mA$	
Forward Transfer Admittance	Y _{fs}	40	-	-	mS	$V_{DS} = 3V, I_{D} = 300 \text{mA}$	
Diode Forward Voltage	V _{SD}	-	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 300mA$	
DYNAMIC CHARACTERISTICS						-	
Input Capacitance	C _{iss}	-	67.62	-	pF		
Output Capacitance	Coss	-	9.74	-	pF	−V _{DS} = 25V, V _{GS} = 0V, −f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	-	7.58	-	pF		
Gate Resistance	Rg	-	68.51	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (Note 8)	Qq	-	0.89	2	nC		
Gate-Source Charge	Q _{gs}	-	0.14	-	nC	$V_{GS} = 4.5V, V_{DS} = 15V,$ $I_{D} = 1A$	
Gate-Drain Charge	Q _{gd}	-	0.16	-	nC		
Turn-On Delay Time	t _{D(on)}	-	4.92	-	ns		
Turn-On Rise Time	tr	-	6.93	-	ns	$V_{DS} = 10V, I_{D} = 1A$	
Turn-Off Delay Time	t _{D(off)}	-	21.71	-	ns	$V_{GS} = 10V, R_{G} = 6\Omega$	
Turn-Off Fall Time	t _f	-	10.62	-	ns	7	

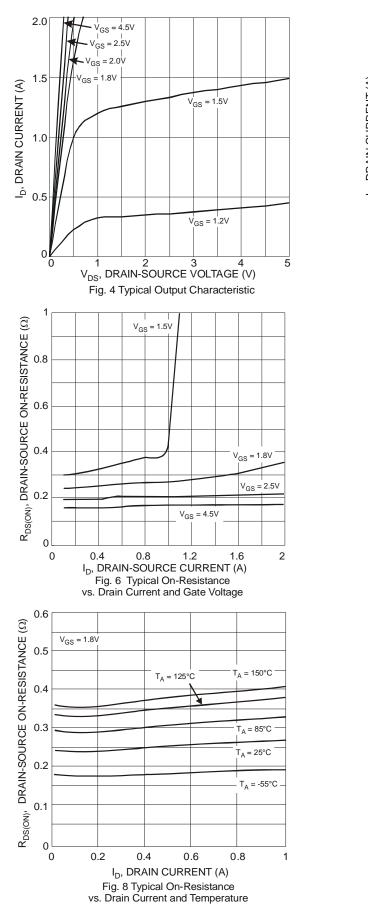
Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guarantee by design.

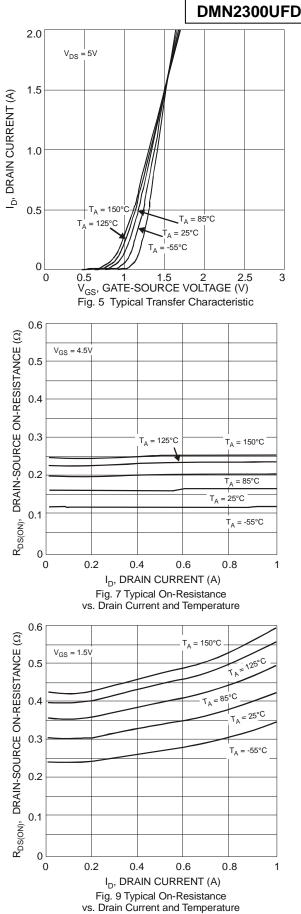
DMN2300UFD Datasheet Number: DS35443 Rev. 2 - 2



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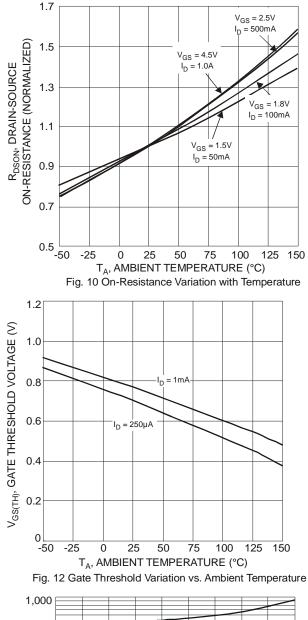


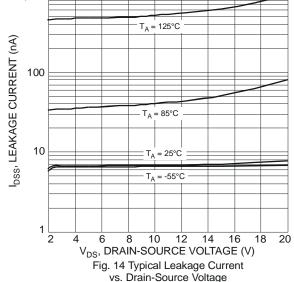




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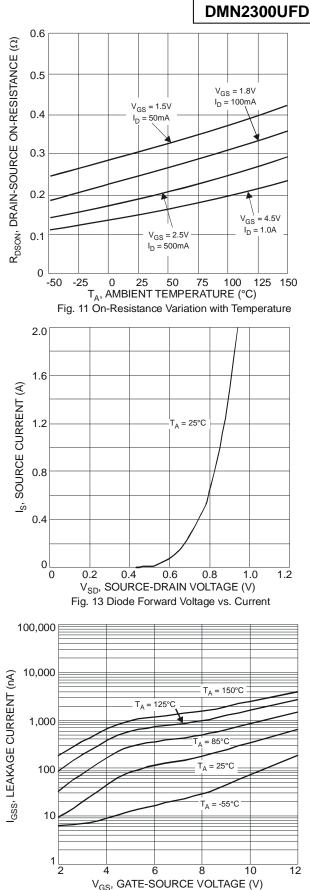
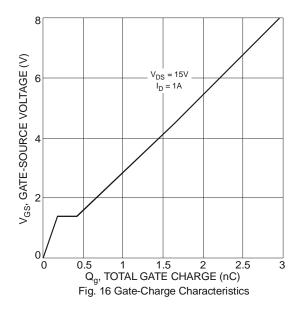


Fig.15 Leakage Current vs. Gate-Source Voltage

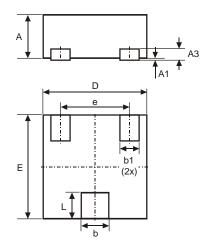
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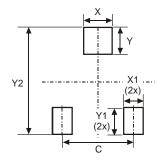


Package Outline Dimensions



X1-DFN1212-3							
Dim	Min	Max	Тур				
Α	0.47	0.53	0.50				
A1	0	0.05	0.02				
A3	-	-	0.13				
b	0.27	0.37	0.32				
b1	0.17	0.27	0.22				
D	1.15	1.25	1.20				
Е	1.15	1.25	1.20				
е	1	1	0.80				
L	0.25	0.35	0.30				
All Di	mens	ions i	n mm				

Suggested Pad Layout



Dimensions	Value (in mm)
С	0.80
Х	0.42
X1	0.32
Y	0.50
Y1	0.50
Y2	1.50

DMN2300UFD Datasheet Number: DS35443 Rev. 2 - 2



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